



SMD Comm X8G HT150C Flex, Ceramic, 91 pF, 20%, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.4 mm



| General Information | |
|--------------------------|--|
| Series | SMD Comm X8G HT150C Flex |
| Style | SMD Chip |
| Description | SMD, MLCC, High Temperature, Ultra-Stable |
| Features | High Temperature, Ultra-Stable |
| RoHS | Yes |
| Termination | Flexible Termination |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 4.6 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Dimensions | |
|------------|------------------|
| Chip Size | 0603 |
| L | 1.6mm +/-0.17mm |
| W | 0.8mm +/-0.15mm |
| Т | 0.8mm +/-0.15mm |
| S | 0.4mm MIN |
| В | 0.45mm +/-0.15mm |
| | |

15000

Packaging Quantity

| L | 1.6mm +/-0.1/mm | Measurement Condition |
|--------------------------|------------------------|-------------------------------|
| W | 0.8mm +/-0.15mm | Tolerance |
| Т | 0.8mm +/-0.15mm | Voltage DC |
| S | 0.4mm MIN | Dielectric Withstanding Volta |
| В | 0.45mm +/-0.15mm | Temperature Range |
| | | Temp. Coefficient |
| Packaging Specifications | | Capacitance Change with |
| Packaging | T&R, 330mm, Paper Tape | Reference to +25°C and 0 VD |

| Specifications | |
|--|--|
| Capacitance | 91 pF |
| Measurement Condition | 1 MHz 1.0Vrms |
| Tolerance | 20% |
| Voltage DC | 200 VDC |
| Dielectric Withstanding Voltage | 500 VDC |
| Temperature Range | -55/+150°C |
| Temp. Coefficient | X8G |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 100 GOhms |

| Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and | d |
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